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SERIAL NUMBER 10/529,742	FILING OR 371(c) DATE 01/06/2006 RULE	CLASS 438	GROUP ART UNIT 1765	ATTORNEY DOCKET NO. 268844USOPCT
APPLICANTS Hiroshi Shiho, Tokyo, JAPAN; Yukio Hosaka, Tokyo, JAPAN; Kou Hasegawa, Tokyo, JAPAN; Nobuo Kawahashi, Tokyo, JAPAN;				
** CONTINUING DATA ***** <i>KCC</i> This application is a 371 of PCT/JP04/05963 04/23/2004 ** FOREIGN APPLICATIONS ***** <i>KCC</i>				
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 08/15/2006				
Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and Acknowledged <i>KCC</i> Examiner's Signature Initials		STATE OR COUNTRY JAPAN	SHEETS DRAWING 9	TOTAL CLAIMS 17
		INDEPENDENT CLAIMS 3		
ADDRESS 22850				
TITLE Polishing pad for semiconductor wafer, polishing multilayered body for semiconductor wafer having same, and method for polishing semiconductor wafer				
FILING FEE RECEIVED 900	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	